

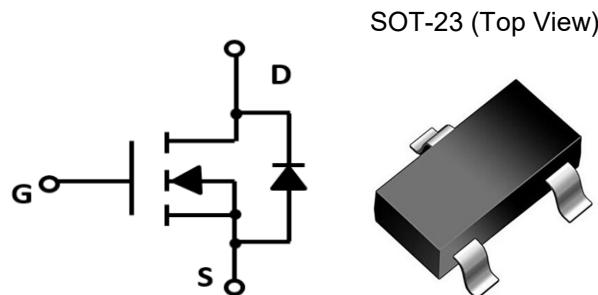
## Description

CM3400NJ is the N-Channel enhancement mode power field effect transistors with high cell density, trench technology. This high density process and design have been optimized switching performance and especially tailored to minimize on-state resistance.

## Features

- V<sub>DS</sub>: 30V
- I<sub>D</sub>: 5.3A
- R<sub>DS(on)</sub> (@V<sub>GS</sub>=10V) : < 30mΩ
- R<sub>DS(on)</sub> (@V<sub>GS</sub>=4.5V) : < 33mΩ
- R<sub>DS(on)</sub> (@V<sub>GS</sub>=2.5V) : < 51mΩ
- High density cell design for extremely low R<sub>DS(on)</sub>
- Excellent on-resistance and DC current capability

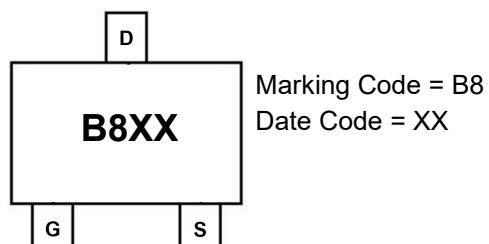
## Equivalent Circuit and Pin Configuration



## Applications

- Cellular Handsets and Accessories
- Personal Digital Assistants
- Portable Instrumentation
- Load switch

## Marking Information



## Ordering Information

Part Number	Packaging	Reel Size
CM3400NJ	3000/Tape & Reel	7 inch

## Absolute Maximum Ratings (TA=25 °C unless otherwise noted)

Parameter	Symbol	Maximum	Unit
Drain-source Voltage	V <sub>DS</sub>	30	V
Gate-source Voltage	V <sub>GS</sub>	±10	V
Continuous Drain Current	I <sub>D</sub>	5.3	A
		4.1	A
Pulsed Drain Current <sup>(1)</sup>	I <sub>DM</sub>	21	A
Total Power Dissipation @ TA=25°C <sup>(2)</sup>	P <sub>D</sub>	1.3	W
Thermal Resistance Junction-to-Ambient <sup>(2)</sup>	R <sub>θJA</sub>	100	°C/W
Junction and Storage Temperature Range	T <sub>J,T STG</sub>	-55 to +150	°C

**Electrical Characteristics (T<sub>J</sub>=25 °C unless otherwise noted)**

Parameter	Symbol	Conditions	Min	Typ	Max	Units
<b>Static Parameter</b>						
Drain-Source Breakdown Voltage	BVDSS	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	30			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>D</sub> S=30V, V <sub>GS</sub> =0V, T <sub>C</sub> =25°C			1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±10V, V <sub>D</sub> S=0V			±100	nA
Gate Threshold Voltage	V <sub>GS</sub> (th)	V <sub>D</sub> S=V <sub>GS</sub> , I <sub>D</sub> =250μA	0.6		1.3	V
Static Drain-Source on-Resistance	R <sub>D</sub> S(on)	V <sub>GS</sub> =10V, I <sub>D</sub> =4A		25	30	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =3A		28	33	
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =3A		39	51	
Diode Forward Voltage	V <sub>D</sub> F	I <sub>S</sub> =5.3A, V <sub>GS</sub> =0V		0.9	1.2	V
Maximum Body-Diode Continuous Current	I <sub>S</sub>				5.3	A
<b>Dynamic Parameters</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>D</sub> S=15V, V <sub>GS</sub> =0V, f=1MHz		480		pF
Output Capacitance	C <sub>oss</sub>			44		
Reverse Transfer Capacitance	C <sub>rss</sub>			39		
<b>Switching Parameters</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>GS</sub> =4.6V, V <sub>D</sub> S=15V, I <sub>D</sub> =5.8A		5.8		nC
Gate Source Charge	Q <sub>gs</sub>			0.8		
Gate Drain Charge	Q <sub>gd</sub>			2.2		
Turn-on Delay Time	t <sub>D</sub> (on)	V <sub>GS</sub> =4.5V, V <sub>DD</sub> =15V, I <sub>D</sub> =1A, R <sub>GEN</sub> =2.8Ω		15.6		ns
Turn-on Rise Time	t <sub>r</sub>			9.8		
Turn-off Delay Time	t <sub>D</sub> (off)			118		
Turn-off Fall Time	t <sub>f</sub>			36		

Noted: (1) Pulse Test: Pulse Width≤300us,Duty cycle ≤2%.

(2) Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch. With 2oz Copper ,t≤10s

## Typical Performance Characteristics

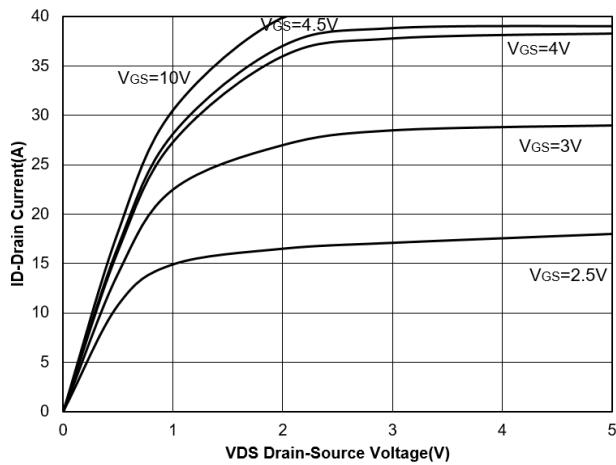


Figure 1. Output Characteristics

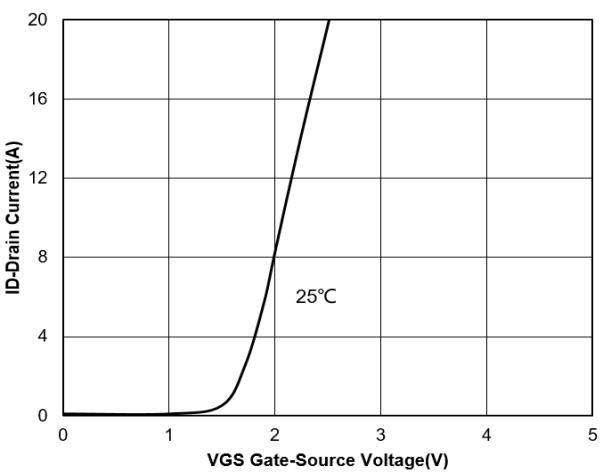


Figure 2. Transfer Characteristics

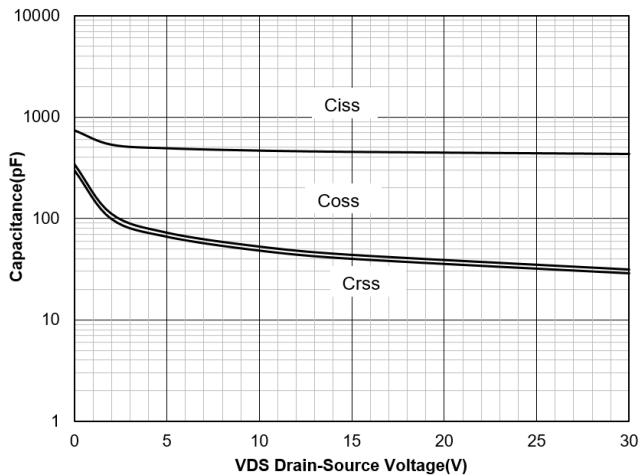


Figure 3. Capacitance Characteristics

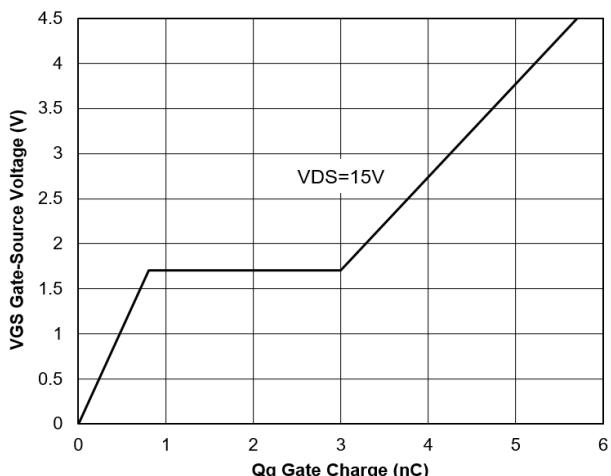


Figure 4. Gate Charge

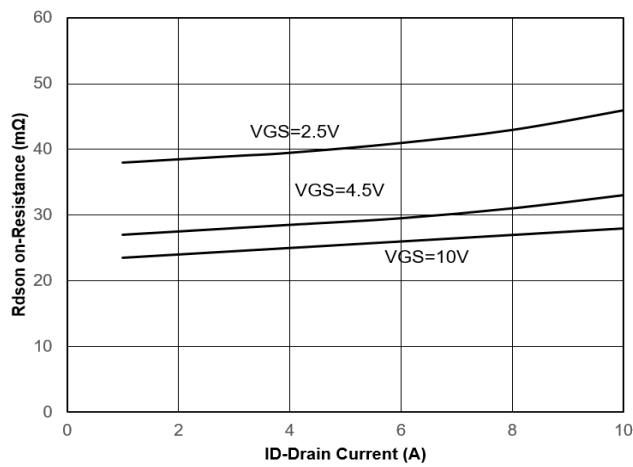


Figure 5. Drain-Source on Resistance

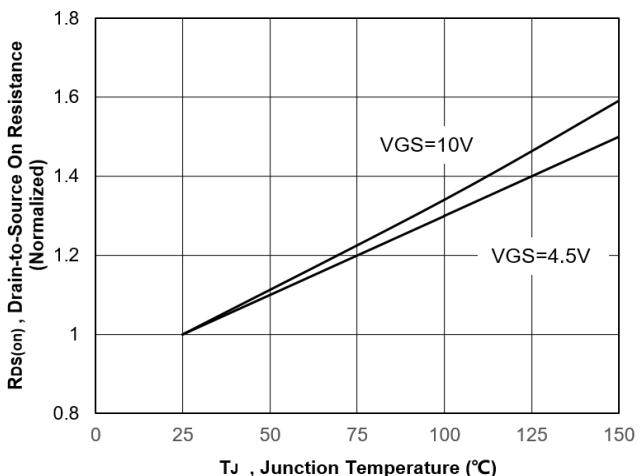


Figure 6. Normalized On-Resistance Vs. Temperature

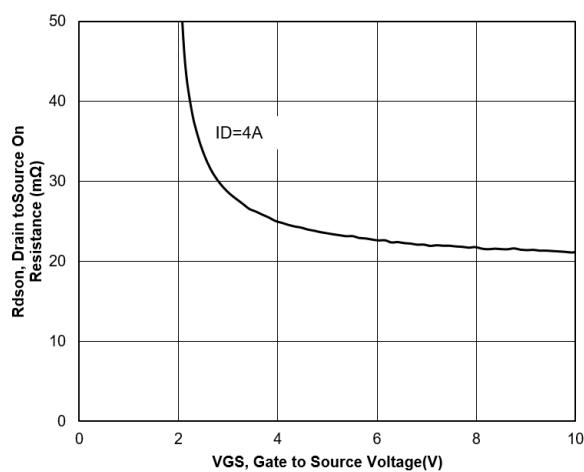


Figure 7. Typical Drain to Source ON Resistance  
VS Gate Voltage and Drain Current

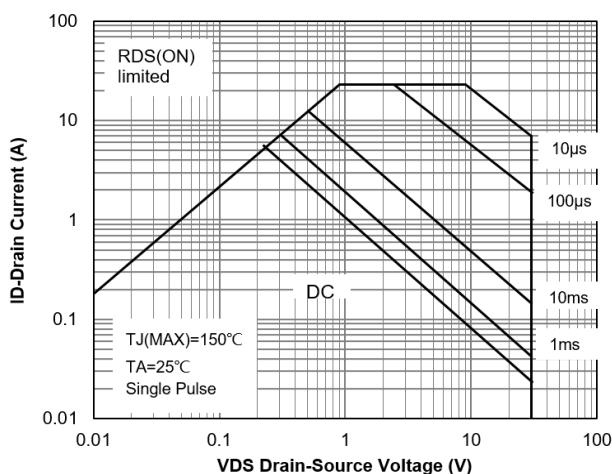


Figure 8. Safe Operation Area

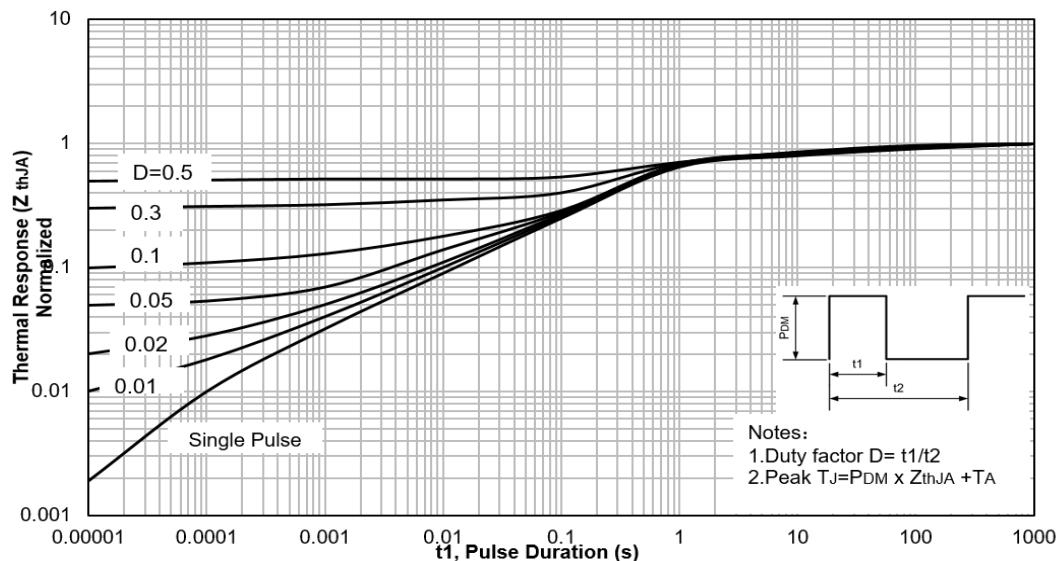


Figure 9. Maximum Effective Transient Thermal Impedance ,Junction-to-Ambient

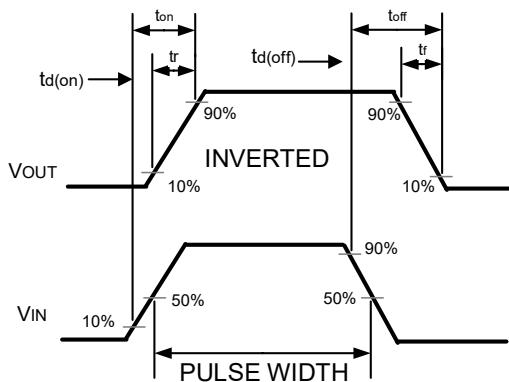
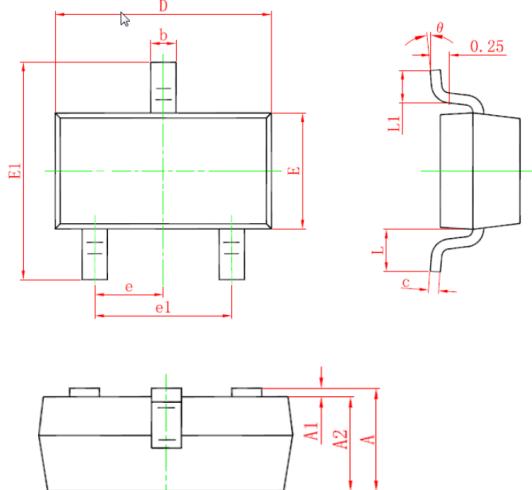


Figure 10. Switching wave

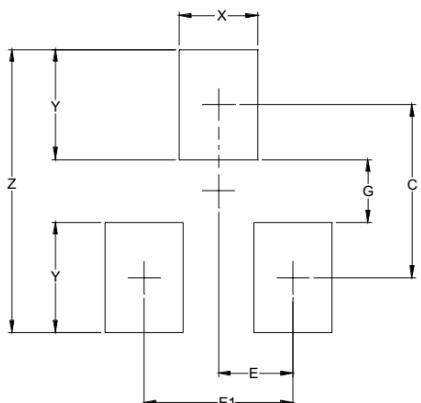
## SOT-23 Package Outline Drawing

(Unit : mm)



SYM	DIMENSIONS					
	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.90	--	1.15	0.035	--	0.045
A1	0.00	--	0.10	0.000	--	0.004
A2	0.90	--	1.05	0.035	--	0.041
b	0.30	--	0.50	0.012	--	0.020
c	0.08	--	0.15	0.003	--	0.006
D	2.80	--	3.00	0.110	--	0.118
E	1.20	--	1.40	0.047	--	0.055
E1	2.25	--	2.55	0.089	--	0.100
e	0.95TYP			0.037TYP		
e1	1.80	--	2.00	0.071	--	0.079
L	0.55REF			0.022REF		
L1	0.30	--	0.50	0.012	--	0.020
Θ	0°	--	8°	0°	--	8°

## Suggested Land Pattern



SYM	DIMENSIONS	
	INCHES	MILLIMETERS
C	0.087	2.20
E	0.037	0.95
E1	0.075	1.90
G	0.031	0.80
X	0.039	1.00
Y	0.055	1.40
Z	0.141	3.60